

Amendments to and Listing of the Claims:

Please cancel claims 1-5, without prejudice, as shown below in the following listing of all claims ever presented. The following listing of claims replaces all prior versions of the claims.

1-5. (Canceled)

6. (Original) A method of producing a semiconductor device, comprising a step of forming a copper wiring by chemical mechanical polishing and washing with washing liquid for a semiconductor substrate comprising a basic compound and at least one selected from the group consisting of sugar alcohols and saccharides.

7. (Original) The method according to Claim 6, wherein the sugar alcohols are mannitol.

8. (Original) The method according to Claim 6, wherein the basic compound is a quaternary ammonium hydroxide.

9. (Original) The method according to Claim 6, wherein the concentration of the sugar alcohol is from 0.01 to 5 wt%.

10. (Original) The method according to Claim 6, wherein the concentration of the basic compound is from 0.05 to 1 wt%.